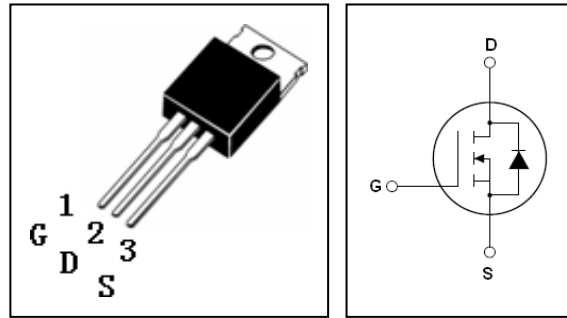


**Main Product Characteristics:**

$V_{DSS}$	100V
$R_{DS(on)}$	5.8mohm(Typ)
$I_D$	130A


**SSF1007 TOP View (TO220)**
**Features and Benefits:**

- Advanced trench MOSFET process technology
- Special designed for convertors and power controls
- Ultra low on-resistance
- 175°C operating temperature
- High Avalanche capability and 100% tested

**Description:**

It utilizes the latest trench processing techniques to achieve the high cell density and reduces the on-resistance with high repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in power switching application and a wide variety of other applications.

**Absolute max Rating:**

Symbol	Parameter	Max.	Units
$I_D$ @ TC = 25°C	Continuous Drain Current, VGS @ 10V <sup>①</sup>	130	A
$I_D$ @ TC = 100°C	Continuous Drain Current, VGS @ 10V <sup>①</sup>	91	
$I_{DM}$	Pulsed Drain Current <sup>②</sup>	520	
$P_D$ @TC = 25°C	Power Dissipation <sup>③</sup>	258	W
	Linear derating factor	1.7	W/ C°
VGS	Gate-to-Source Voltage	± 20	V
EAS	Single Pulse Avalanche Energy @ L=0.3mH <sup>②</sup>	735	mJ
IAR	Avalanche Current @ L=0.3mH <sup>②</sup>	75	A
TJ TSTG	Operating Junction and Storage Temperature Range	-55 to + 175	°C

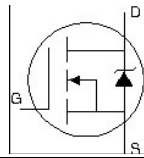
**Thermal Resistance**

Symbol	Characterizes	Value	Unit
$R_{\theta JC}$	Junction-to-case <sup>③</sup>	0.58	°C/W
$R_{\theta JA}$	Junction-to-ambient (t ≤ 10s) <sup>④</sup>	62	°C/W

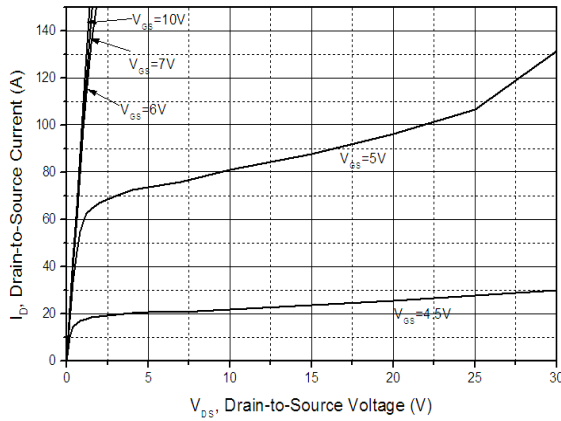
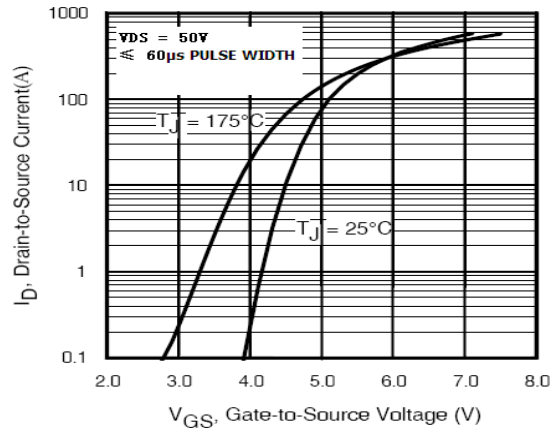
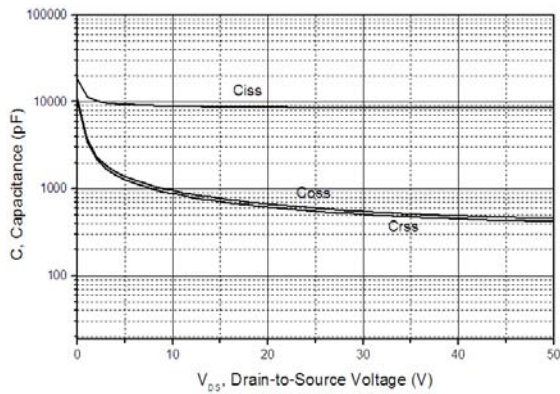
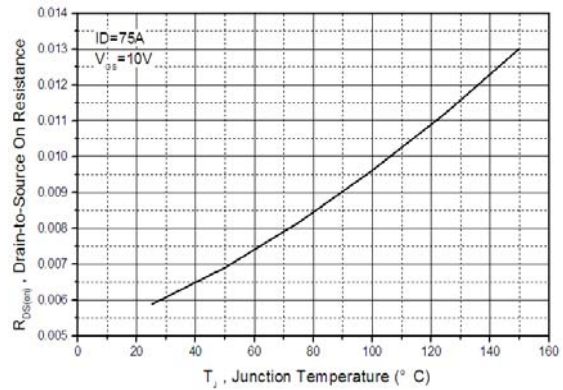
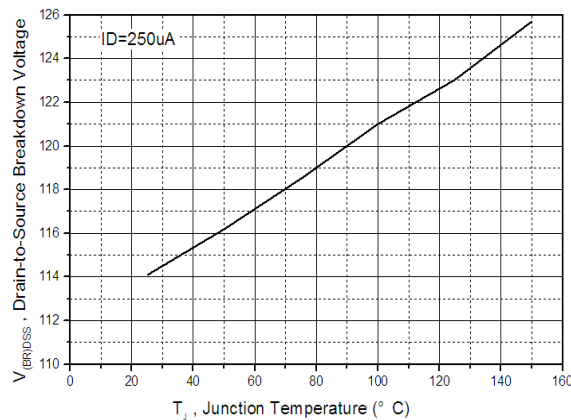
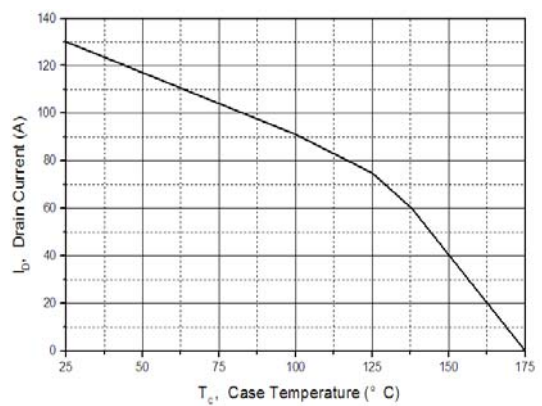
**Electrical Characterizes @ $T_A=25^{\circ}\text{C}$  unless otherwise specified**

Symbol	Parameter	Min.	Typ.	Max	Units	Conditions
BVDSS	Drain-to-Source breakdown voltage	100	—	—	V	VGS = 0V, ID = 250 $\mu$ A
RDS(on)	Static Drain-to-Source on-resistance	—	5.8	7	m $\Omega$	VGS = 10V, ID = 75A <sup>③</sup>
VGS(th)	Gate threshold voltage	2	—	4	V	VDS = VGS, ID = 250 $\mu$ A
IDSS	Drain-to-Source leakage current	—	—	20	$\mu$ A	VDS = 100V, VGS = 0V
		—	—	250		VDS = 80V, VGS = 0V, TJ = 125 $^{\circ}$ C
IGSS	Gate-to-Source forward leakage	—	—	100	nA	VGS = 20V
	Gate-to-Source reverse leakage	—	—	-100		VGS = -20V
Qg	Total gate charge	—	243	—	nC	ID = 75A VDS = 50V VGS = 10V <sup>③</sup>
Qgs	Gate-to-Source charge	—	47	—		
Qgd	Gate-to-Drain("Miller") charge	—	92	—		
td(on)	Turn-on delay time	—	28	—	ns	VDD = 65V ID = 75A RG = 2.7 $\Omega$ VGS = 10V <sup>③</sup>
tr	Rise time	—	108	—		
td(off)	Turn-Off delay time	—	123	—		
tf	Fall time	—	120	—		
Ciss	Input capacitance	—	8456	—	pF	VGS = 0V VDS = 50V f = 500KHz
Coss	Output capacitance	—	454	—		
Crss	Reverse transfer capacitance	—	417	—		

**Source-Drain Ratings and Characteristics**

	Parameter	Min.	Typ.	Max	Units	Conditions
IS	Continuous Source Current (Body Diode)	—	—	130	A	MOSFET symbol showing the integral reverse p-n junction diode. 
ISM	Pulsed Source Current (Body Diode) ①	—	—	520		TJ = 25 $^{\circ}$ C, IS = 75A, VGS = 0V <sup>③</sup>
VSD	Diode Forward Voltage	—	—	1.3	V	TJ = 25 $^{\circ}$ C, IF = 75A, VDD = 20V di/dt = 100A/ $\mu$ s <sup>③</sup>
Trr	Reverse Recovery Time	—	57	70	ns	TJ = 25 $^{\circ}$ C, IF = 75A, Vgs=0V di/dt = 100A/ $\mu$ s <sup>③</sup>
Qrr	Reverse Recovery Charge	—	156	170	nC	
ton	Forward Turn-on Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

## Typical electrical and thermal characteristics


**Figure 1. Typical Output Characteristics**

**Figure 2. Typical Transfer Characteristics**

**Figure 3. Typical Capacitance Vs. Drain-to-Source Voltage**

**Figure 4. Normalized On-Resistance Vs. Case Temperature**

**Figure 5. Drain-to-Source Breakdown Voltage vs. Temperature**

**Figure 6. Maximum Drain Current Vs. Case Temperature**

### Typical electrical and thermal characteristics

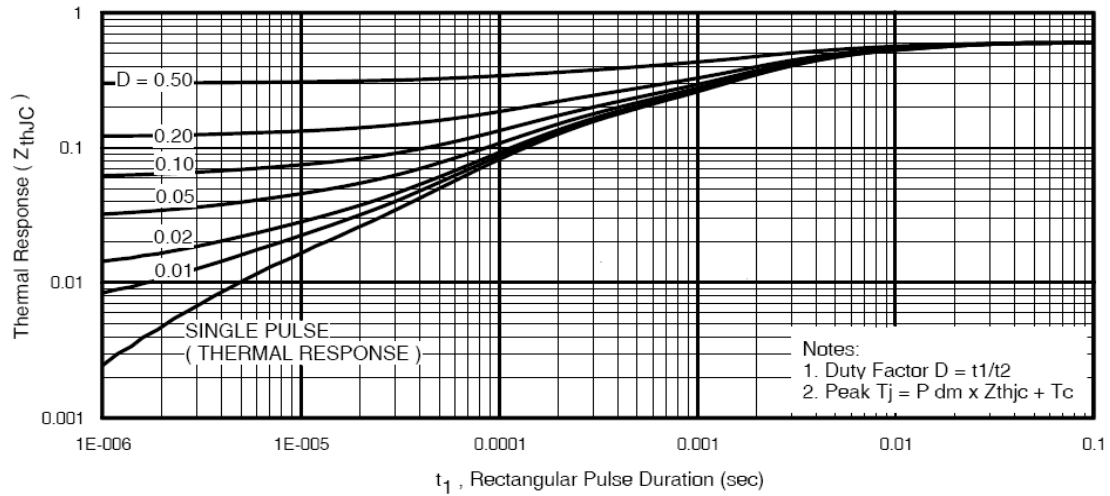
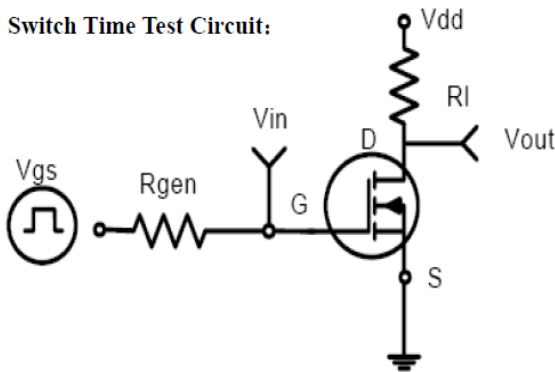
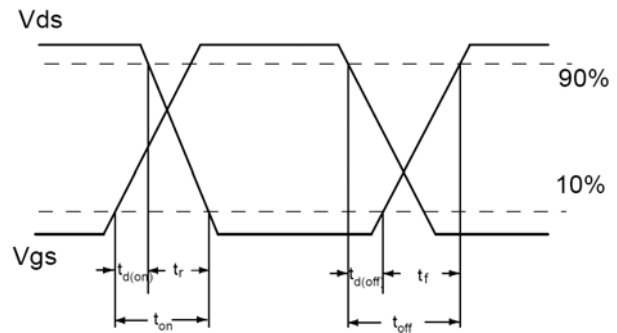


Figure 7. Maximum Effective Transient Thermal Impedance, Junction-to-Case

Switch Time Test Circuit:



Switch Waveforms

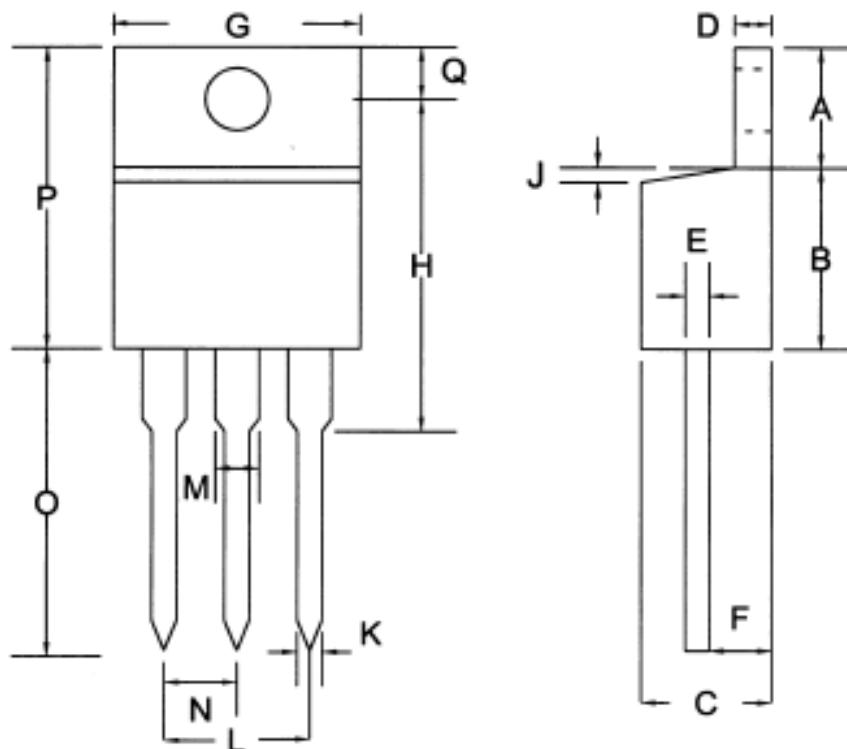


**Notes:**

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T<sub>Jmax</sub>, starting T<sub>J</sub> = 25°C, L = 0.3mH R<sub>G</sub> = 50Ω, I<sub>AS</sub> = 70A, V<sub>GS</sub> = 10V. Part not recommended for use above this value.
- ③ Pulse width < 1.0ms; duty cycle < 2%.
- ④ This is only applied to TO-220 package

**Mechanical Data:**

TO220



Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min	Nom	Max	Min	Nom	Max
A	5.58	6.54	7.49	0.220	0.257	0.295
B	8.38	8.64	8.90	0.330	0.340	0.350
C	4.07	4.45	4.82	0.160	0.175	0.190
D	1.15	1.27	1.39	0.045	0.050	0.055
E	0.35	0.45	0.60	0.014	0.018	0.024
F	2.04	2.42	2.79	0.080	0.095	0.110
G	9.66	9.97	10.28	0.380	0.393	0.405
H	—	16.25	—	—	0.640	—
I	3.68	3.83	3.98	0.145	0.151	0.157
J	—	—	1.27	—	—	0.050
K	0.75	0.85	0.95	0.030	0.033	0.037
L	4.83	5.08	5.33	0.190	0.200	0.210
M	1.15	1.33	1.52	0.045	0.052	0.060
N	2.42	2.54	2.66	0.095	0.100	0.105
O	12.70	13.48	14.27	0.500	0.531	0.562
P	14.48	15.17	15.87	0.570	0.597	0.625
Q	2.54	2.79	3.04	0.100	0.110	0.120